



12V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
-12V	11mΩ @ V _{GS} = -4.5V	-11A
	14mΩ @ V _{GS} = -3.7V	-9.7A
	19mΩ @ V _{GS} = -2.5V	-8.3A
	30mΩ @ V _{GS} = -1.8V	-6.6A

Description

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

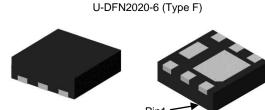
- **Battery Management Application**
- **Power Management Functions**
- DC-DC Converters

Features

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMP1009UFDFQ)

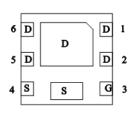
Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.007 grams (Approximate)

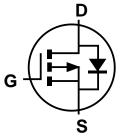




Bottom View



Pin Out **Bottom View**



Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMP1009UFDF-7	U-DFN2020-6 (Type F)	3,000/Tape & Reel
DMP1009UFDF-13	U-DFN2020-6 (Type F)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain < 900ppm bromine, < 900ppm chlorine (< 1500ppm total Br + Cl) and
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



Marking Information

Site 1



FZ = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Kev

Year	2017		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	Е		Ι	- 1	J	K	L	М	N	0	Р	R
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



FZ = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Kev

Date Code Key												
Year	2017		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	7		0	1	2	3	4	5	6	7	8	9
Week	1-26			1	27	E2		53				
			-20		27-52				ეე			
Code		A-Z a-z z					a-z			7		
Internal Code	Sun	1	Mon		Tue	W	ed	Thu		Fri		Sat
Code	Т		U		V	V	٧	Χ		Υ		Z



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	-12	V		
Gate-Source Voltage	V _{GSS}	±8	V		
Continuous Drain Current V 4 5 V (Note 6)	lo	-11 -8.7	А		
Continuous Drain Current V _{GS} = -4.5V (Note 6)	$T_A = +25$ °C $T_A = +70$ °C	lo	-15 -12	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	-70	Α
Maximum Body Diode Continuous Current (Note 6)	Is	-2.5	Α		
Avalanche Current (Note 7) L = 0.1mH	las	-24	Α		
Avalanche Energy (Note 7) L = 0.1mH			Eas	31	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.8	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	152	°C/W	
mermai Resistance, Junction to Ambient (Note 5)	t<5s	RθJA	81		
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	PD	2.0	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	р	63		
Thermal Resistance, Junction to Ambient (Note 6)	t<5s	$R_{\theta JA}$	34	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Steady State	R _θ JC	15		
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C		

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)			- 71			100100111111111111111111111111111111111
Drain-Source Breakdown Voltage	BV _{DSS}	-12	_	_	V	V _G S = 0V, I _D = -250µA
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-100	nA	V _{DS} = -9.6V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	Vgs = ±8V, Vps = 0V
ON CHARACTERISTICS (Note 8)						•
Gate Threshold Voltage	Vgs(TH)	-0.3	-	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
			8.3	11		V _G S = -4.5V, I _D = -5A
Static Drain-Source On-Resistance	Decrees		9	14	mΩ	$V_{GS} = -3.7V, I_D = -5A$
Static Drain-Source On-Resistance	RDS(ON)	_	12	19	11122	$V_{GS} = -2.5V, I_{D} = -4A$
			16	30		$V_{GS} = -1.8V, I_{D} = -1A$
Diode Forward Voltage	VsD	_	-0.8	-1.2	V	Vgs = 0V, Is = -10A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	1860			101/11/
Output Capacitance	Coss	_	498		pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	416	_		1 = 1.0001112
Gate Resistance	Rg	_	11	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	26	_		
Total Gate Charge (V _{GS} = -8V)	Qg	_	44	_		\/ C\/ I- 40A
Gate-Source Charge	Qgs	_	3.3	_	nC	$V_{DS} = -6V, I_{D} = -10A$
Gate-Drain Charge	Q _{gd}	_	8.1	_		
Turn-On Delay Time	t _D (ON)	_	7.0	_		
Turn-On Rise Time	t _R	_	10.6	_		$V_{DS} = -6V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(OFF)}	_	62.2	_	ns	$R_G = 1\Omega$, $I_D = -8A$
Turn-Off Fall Time	t _F	_	61			
Reverse Recovery Time	trr	_	34.4	_	ns	1 404 31/34 5004/
Reverse Recovery Charge	Qrr	_	28.1	_	nC	$I_F = -12A$, di/dt = 500A/ μ s

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

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^{7.} I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.

^{8.} Short duration pulse test used to minimize self-heating effect.

^{9.} Guaranteed by design. Not subject to product testing.



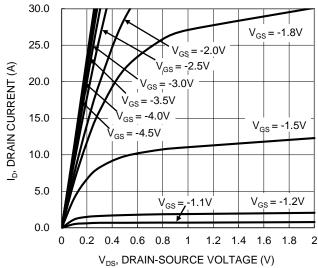


Figure 1. Typical Output Characteristic

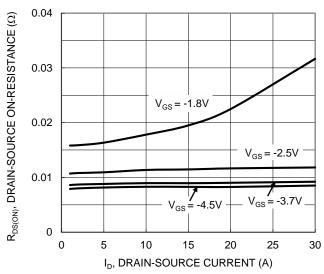


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

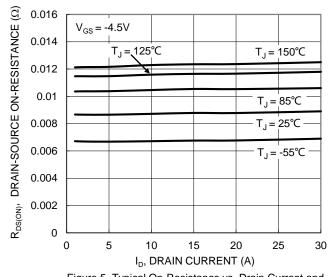


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

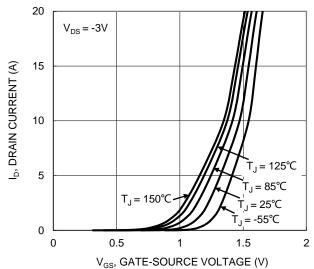


Figure 2. Typical Transfer Characteristic

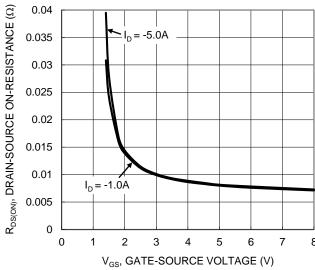


Figure 4. Typical Transfer Characteristic

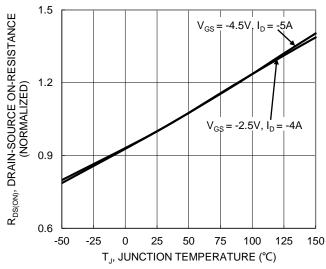


Figure 6. On-Resistance Variation with Temperature



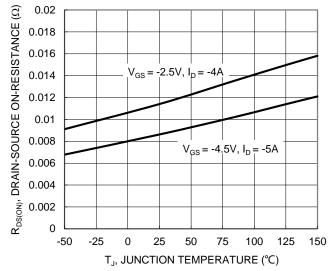


Figure 7. On-Resistance Variation with Temperature

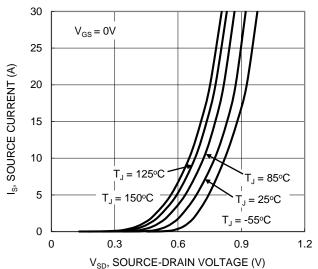


Figure 9. Diode Forward Voltage vs. Current

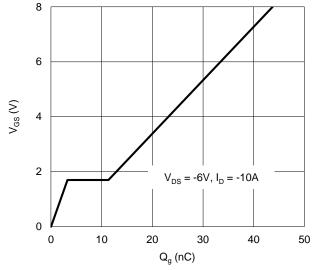


Figure 11. Gate Charge

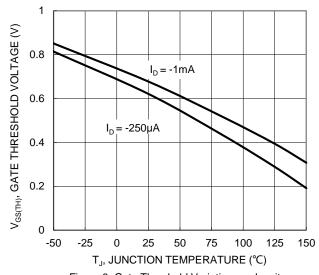


Figure 8. Gate Threshold Variation vs. Junciton Temperature

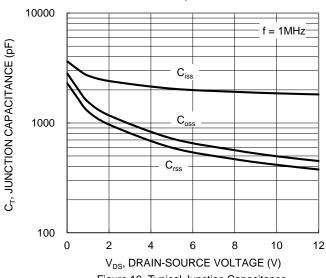


Figure 10. Typical Junction Capacitance

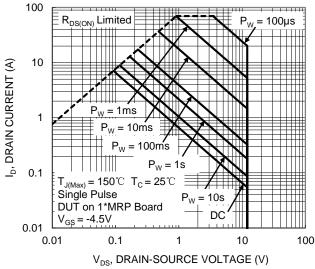


Figure 12. SOA, Safe Operation Area



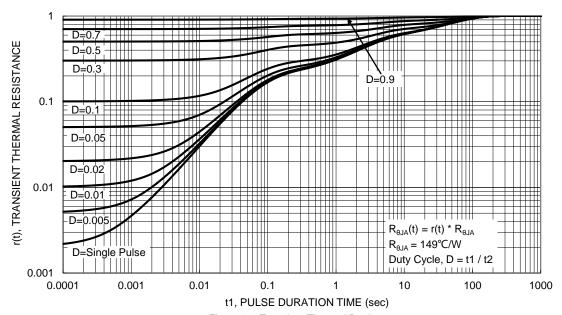


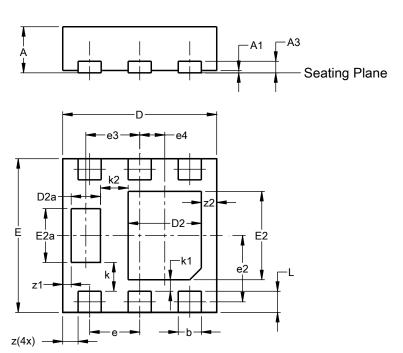
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)

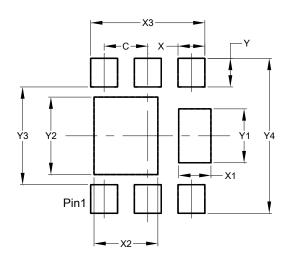


	U-DFN2020-6						
	(Тур	oe F)					
Dim	Min	Max	Тур				
Α	0.57	0.60					
A1	0.00	0.05	0.03				
A3	-	-	0.15				
b	0.25	0.35	0.30				
D	1.95	2.05	2.00				
D2	0.85	1.05	0.95				
D2a	0.33	0.43	0.38				
Е	1.95	2.05	2.00				
E2	1.05	1.25	1.15				
E2a	0.65	0.75	0.70				
е		0.65 BS	С				
e2	().863 BS	SC SC				
е3		0.70 BS	С				
e4	().325 BS	SC .				
k		0.37 BS	_				
k1		0.15 BS					
k2		0.36 BS					
L	0.225	0.325	0.275				
Z		0.20 BS	_				
z 1).110 BS					
z2		0.20 BS	C				
All C	Dimens	ions in	mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



Dimensions	Value (in mm)
С	0.650
X	0.400
X1	0.480
X2	0.950
Х3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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